RENESAS

RJK0389DPA

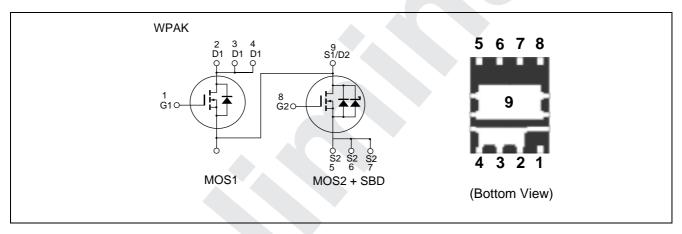
Silicon N Channel Power MOS FET with Schottky Barrier Diode High Speed Power Switching

> REJ03G1722-0102 Preliminary Rev.1.02 Jul 25, 2008

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Pb-free
- Halogen-free

Outline



Absolute Maximum Ratings

				(Ta = 25°C)
		Rat		
Item	Symbol	MOS1	MOS2	Unit
Drain to source voltage	V _{DSS}	30	30	V
Gate to source voltage	V _{GSS}	±20	±20	V
Drain current	ID	15	20	A
Drain peak current	I _{D(pulse)} Note1	60	80	A
Reverse drain current	I _{DR}	15	20	A
Avalanche current	I _{AP} Note 2	8	11	A
Avalanche energy	E _{AR} Note 2	6.4	12.1	mJ
Channel dissipation	Pch Note3	10	10	W
Channel temperature	Tch	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

3. Tc = 25°C

Electrical Characteristics

• MOS1

						(Ta = 25°C)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}		_	±0.1	μA	$V_{GS} = \pm 20 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}		_	1	μA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.2	_	2.5	V	$V_{DS} = 10 \text{ V}, \ I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}		8.2	10.7	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}		11.8	16.5	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	_	TBD	_	S	$I_D = 7.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	860	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	165		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	53		pF	f = 1 MHz
Gate Resistance	Rg	_	4.2	_	Ω	
Total gate charge	Qg	_	6.3	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	2.3	_	nC	$V_{GS} = 4.5 V$
Gate to drain charge	Qgd	_	1.4		nC	I _D = 15 A
Turn-on delay time	t _{d(on)}	_	TBD	1	ns	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$
Rise time	tr	_	TBD		ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	t _{d(off)}	_	TBD	-	ns	R _L = 1.33 Ω
Fall time	t _f	_	TBD	—	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	V _{DF}		0.84	1.10	V	$I_F = 15 \text{ A}, V_{GS} = 0^{Note4}$
Body–drain diode reverse	t _{rr}	—	20		ns	$I_F = 15 \text{ A}, V_{GS} = 0$
recovery time						di⊧/ dt = 100 A/µs

Notes: 4. Pulse test

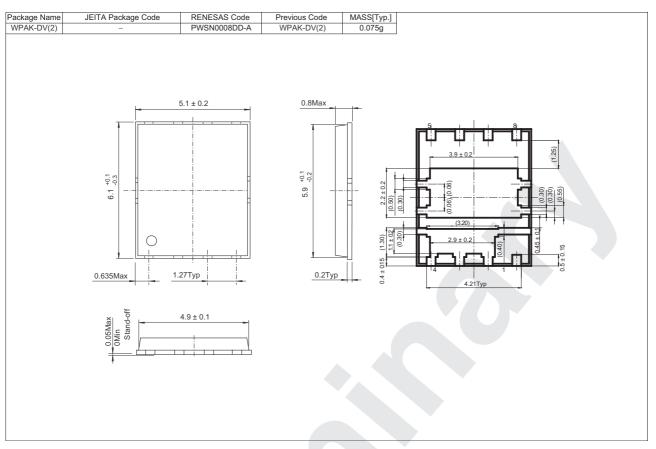
• MOS2

$(1a = 25^{\circ}C)$	$^{\circ}C)$	25°	a =	(T	
----------------------	--------------	-----	-----	----	--

Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	mA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.2	—	2.5	V	V _{DS} = 10 V, I _D =1 mA
Static drain to source on state	R _{DS(on)}	_	6.8	8.9	mΩ	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	10.5	14.7	mΩ	$I_D = 10 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	_	TBD		S	$I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	1000		pF	V _{DS} = 10 V
Output capacitance	Coss	_	240	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	100		pF	f = 1 MHz
Gate Resistance	Rg	_	4.5		Ω	
Total gate charge	Qg	_	7.2		nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	2.9		nC	$V_{GS} = 4.5 V$
Gate to drain charge	Qgd	_	2.2		nC	I _D = 20 A
Turn-on delay time	t _{d(on)}	_	TBD		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$
Rise time	tr	_	TBD		ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	t _{d(off)}	_	TBD	_	ns	$R_L = 1.0 \Omega$
Fall time	t _f	_	TBD		ns	$R_g = 4.7 \Omega$
Schottky Barrier diode forward voltage	VF	_	0.44	-	V	$I_F = 2 A, V_{GS} = 0^{Note4}$
Body–drain diode reverse	t _{rr}	_	12	-	ns	$I_F = 20 \text{ A}, V_{GS} = 0$
recovery time						di _F / dt = 100 A/µs

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK0389DPA-00-J0	2500 pcs	Taping

RenesasTechnology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

- Benesas lechnology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
 Pines
 This document is provided for reference purposes only so that Renesas customers may select the appropriate Renesas products for their use. Renesas neither makes warranties or representations with respect to the accuracy or completeness of the information in this document.
 But not infinited to, product data. diagrams, charts, programs, algorithms, and application scuch as the development of weapons of mass and regulations, and proceedures required by such laws and regulation.
 All information in this document, included in this document for the purpose of military application scuch as the development of weapons of mass and regulations, and proceedures required by such laws and regulations.
 All information included in this document such as product data, diagrams, charts, programs, algorithms, and application carcuit examples, is current as of the date this document, when exporting the products or the technology described herein, you should follow the applicable export control laws and regulations, and proceedures required by such laws and regulations.
 Renesas has used reasonable care in compiling the information in this document, but Renesas assumes no liability whatsoever for any damages incurred as a fast stude of the document. You should evaluate the information in light of the total system before deciding about the applicability or there were provided specific by series as subal table. The subality of the series of the subality of the series of the subality of the series as subality of the series of any damages incurred as a state of the date this document.
 When using or otherwise regulations in the information in this document. Dut Renesas as subality of that series of any damages incurred as a state of otherwise systems for transportation and traffic by the series of the series of the series of the series of the



RENESAS SALES OFFICES

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K. Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd. Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7858/7898

Renesas Technology Hong Kong Ltd. 7th Floor, North Tower, World Finance Centre, Harbour City, Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2377-3473

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 3518-3399

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

http://www.renesas.com